

SCRs

查询GB301A供应商

Commercial Nanosecond Switching Planar

GA300 GB300
GA300A GB300A
GA301 GB301
GA301A GB301A

24小时加急出货

FEATURES

- Rise Time: 10ns
- Delay Time: 10ns
- Recovery Time: 0.5 μ s
- Pulse Current: to 100A
- Turn-on with 20ns, 10mA gate pulse

DESCRIPTION

The Microsemi Nanosecond Thyristor Switch combines the turn-on speed of logic level transistors with the high current switching capability inherent in SCRs. With this device engineers can now design circuits capable of switching pulse currents of 1A in less than 10ns or up to 30A in less than 20ns.

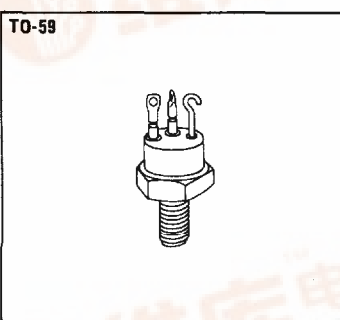
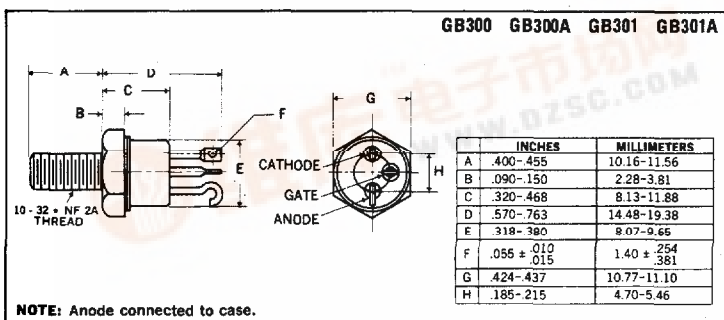
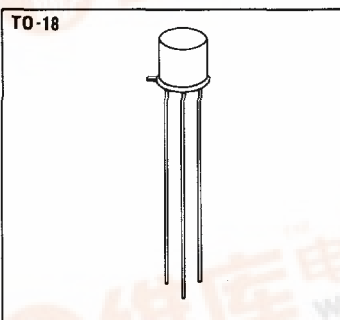
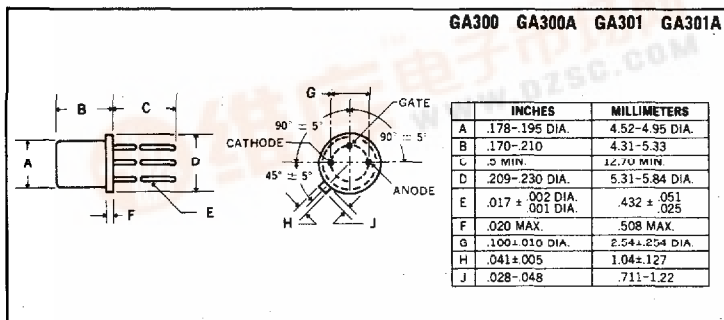
The GA300, GB300 Series is specifically designed for use as switching element in high speed laser diode pulse drivers. Other applications include electronic crowbars, harmonic wave-form generators, line drivers and general purpose replacements for avalanche transistors. For applications requiring higher voltage levels, Microsemi has developed several "series string" circuits which allow the series connection of an unlimited number of devices for voltages as high as 2000V with no significant decrease in speed. The circuits are described in Microsemi's Design Note #14.

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ABSOLUTE MAXIMUM RATINGS

	GA300 GA300A	GA301 GA301A	GB300 GB300A	GB301 GB301A
Repetitive Peak Off-State Voltage, V_{DRM}	60V	100V	60V	100V
Repetitive Peak On-State Current, I_{TRM}	up to 100A	up to 100A	up to 100A	up to 100A
Peak Gate Current, I_{GM}	250mA	250mA	250mA	250mA
Average Gate Current, $I_{G(AV)}$	25mA	25mA	50mA	50mA
Reverse Gate Current, I_{GR}	3mA	3mA	3mA	3mA
Reverse Gate Voltage, V_{GR}	5V	5V	5V	5V
Storage Temperature Range	-65°C to +150°C	-65°C to +150°C	-65°C to +150°C	-65°C to +150°C
Operating Temperature Range	0°C to +125°C	0°C to +125°C	0°C to +125°C	0°C to +125°C

MECHANICAL SPECIFICATIONS



Microsemi Corp.
Watertown
The diode experts

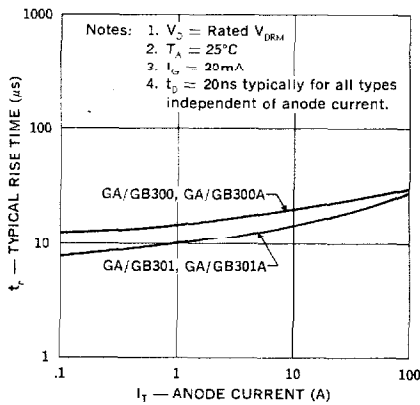
ELECTRICAL SPECIFICATIONS (at 25°C unless noted)

Test	Symbol	Min.	Typical	Max.	Units	Test Conditions
Delay Time	t_d	—	20 10	30 —	ns	$I_G = 20mA, I_T = 1A$ $I_G = 30mA, I_T = 1A$
Rise Time (Note 1) GA300, 300A, GB300, 300A	t_r	—	15 25	25 —	ns	$V_D = 60V, I_T = 1A$ $V_D = 60V, I_T = 30A$ (Note 1)
Rise Time (Note 1) GA301, 301A, GB301, 301A	t_r	—	10 20	20 —	ns	$V_D = 100V, I_T = 1A$ $V_D = 100V, I_T = 30A$ (Note 1)
Circuit Commutated Turn-off Time GA300, 301, GB300, 301	t_q	—	0.8 0.3	2.0 0.5	μs	$I_T = 1A, I_R = 1A, R_{GK} = 1K$ $I_T = 1A, I_R = 1A, R_{GK} = 1K$
Gate Trigger-on Pulse Width	$t_{pg(on)}$	—	0.02	0.05	μs	$I_G = 10mA, I_T = 1A$
Off-state Current	I_{DRM}	—	0.01 20	0.1 100	μA	$V_{DRM} = \text{Rating}, R_{GK} = 1K, T = 25^\circ C$ $V_{DRM} = \text{Rating}, R_{GK} = 1K, T = 125^\circ C$
Reverse Current (Note 2)	I_{RRM}	—	1.0	10	mA	$V_{RRM} = 30V, R_{GK} = 1K$ (Note 2)
Gate Trigger Voltage	V_{GT}	0.4 0.10	0.6 0.2	0.75 —	V	$V_D = 5V, R_{GS} = 100\Omega, T = 25^\circ C$ $V_D = 5V, R_{GS} = 100\Omega, T = 125^\circ C$
Gate Trigger Current	I_{GT}	—	10	200	μA	$V_D = 5V, R_{GS} = 10K$
On-state Voltage	V_T	—	1.1	1.5	V	$I_T = 2A$
Off-state Voltage — Critical Rate of Rise	dv/dt	15	30	—	V/ μs	$V_D = 30V, R_{GK} = 1K$
Reverse Gate Current	I_{GR}	—	0.01	0.1	mA	$V_{GR} = 5V$
Holding Current	I_H	0.3 0.05	2.0 0.4	5.0 —	mA	$V_D = 5V, R_{GK} = 1K, T = 25^\circ C$ $V_D = 5V, R_{GK} = 1K, T = 125^\circ C$

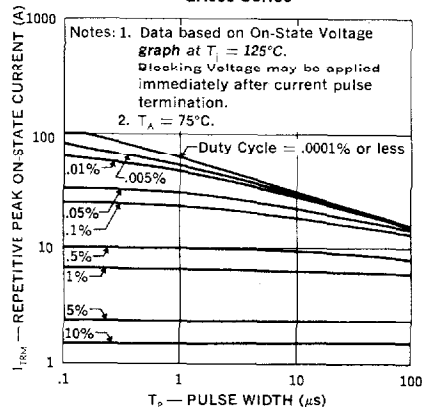
Notes: 1. $I_G = 10mA$, Pulse Test, Duty Cycle $< 1\%$.

2. Pulse test intended to guarantee reverse anode voltage capability for pulse commutation. Device should not be operated in the reverse blocking mode on a continuous basis.

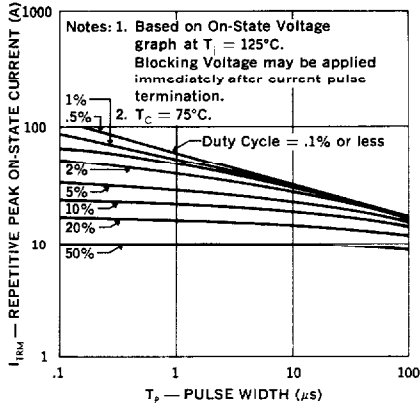
Switching Speed vs. Current
GA/GB300 Series



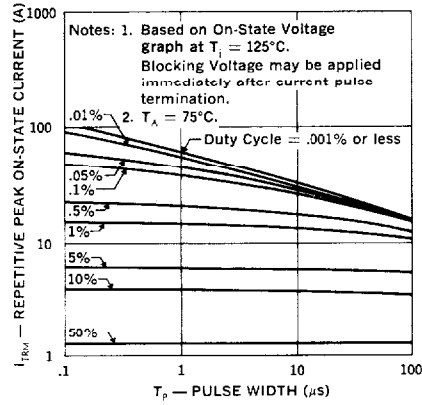
Peak Current vs. Pulse Width
GA300 Series



**Peak Current vs. Pulse Width
GB300 Series**

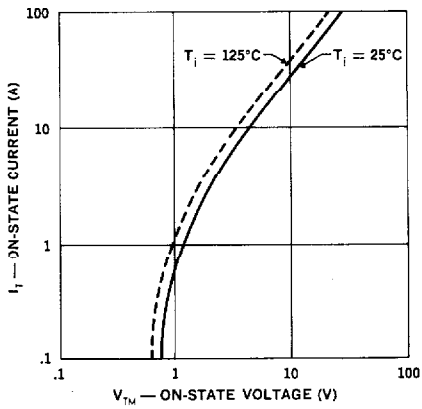


**Peak Current vs. Pulse Width
GB300 Series**



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**On-State Voltage vs. Current
GA/GB300 Series**



**Surge Rating
GA/GB300 Series**

